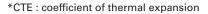
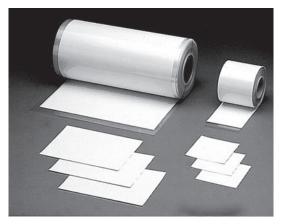
# **Composite Powder for Low Temperature Cofired Ceramics**

Composite powder for low temperature cofired ceramics is a composite material that is made by uniformly blending glass and ceramic fillers. Firing can be conducted at a low temperature in the range of 870-900°C, which allows the use of highly conductive elements such as gold and silver paste to create a screen print circuit pattern with high electric properties.

- MLS-25M is a vitreous material with a low CTE\* and a low dielectric constant.
- MLS-25E is a vitreous material with a very low dielectric constant.
- MLS-41 is a devitrifiable material with a high dielectric constant.
- ullet MLS-23K is a new product with a low dielectric constant and low tan  $\delta$  .
- MLS-26 is a devitrifiable material with high mechanical strength.
- ullet MLS-63 is a devitrifiable material with high mechanical strength and low tan  $\delta$  .





Green sheets

## **Properties**

Properties/Glass Code			MLS-25M	MLS-25E	MLS-41	MLS-23K	MLS-26	MLS-63
Bending strength		MPa	157	125	250	150	320	400
Dielectric constant	1MHz, 25°C		4.9	3.9	17.0	3.9	7.1	8.0
	15GHz, 25°C		4.8	3.9	19.0	4.0	6.7	7.9
tan $\delta$	1MHz, 25°C	×10 <sup>-4</sup>	25	5	20	5	4	5
	15GHz, 25°C	×10-4	47	21	50	15	58	11
Coefficient of thermal expansion	30-380°C	×10 <sup>-7</sup> /K	42	60	84	65	58	87
Density*		×10³kg/m³	2.52	2.29	4.36	2.24	3.02	3.52
Transformation point		°C	500	500	700	525	625	725
Volume resistivity Log ρ	150°C	Ω·cm	13.5	>14	_	>13.8	12	>14
Thermal conductivity		W/m·K	1.9	1.7	3.1	1.7	3.9	4.1
Particle size	D <sub>50</sub>	μm	3.3	3.5	1.1	1.0	2.6	1.6
	D <sub>max</sub>	μm	20	20	10	15	15	10
Glass type			SiO <sub>2</sub> ·B <sub>2</sub> O <sub>3</sub>		Nd <sub>2</sub> O <sub>3</sub> ·TiO <sub>2</sub> ·SiO <sub>2</sub>	SiO <sub>2</sub> ·B <sub>2</sub> O <sub>3</sub>	SiO2·CaO·Al2O3	

<sup>\*</sup>Powder theoretical density

## **Application Examples**

#### Method

### 1. Casting and Printing

Glass-ceramic powder, binder resin, solvent, and plasticizer are thoroughly mixed and cast into a 50-300 µm thick green sheet using the doctor blade method. Individual sheets are cut into appropriate sizes from the green sheet and punched with via holes and then screen-printed with a circuit pattern.

#### 2. Lamination

Green sheets are laminated at 50-100°C and under 10-35 MPa pressure.

## 3. Firing

Firing is carried out in the air.

**Dielectric constant** 

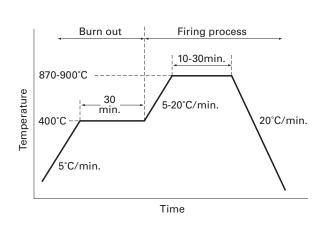


Fig. 1 Firing profile

# **High Frequency Dielectric Properties of MLS-63**

